



DOCUMENT CHANGE REQUEST

DCR number 1051 Changes required for: General

Date: 2017/04/19

Date sent: 2016/11/17

Status: IMPLEMENTED

Originator: Steve Thacker

Organisation: ESCC Executive Secretariat

Title: Integrated Circuits: Monolithic And Multichip Microcircuits, Wire-Bonded, Hermetically Sealed And

Number: 9000

Issue:

8

Other documents affected:

Page:

14

Paragraph:

5.1.1

Original wording:

See 3rd subpara, 4th sub-bullet under bullet item (b) (see 9000 issue 8 Para. 5.1.1):

.....

(b) For Flip-chip Integrated Circuit components:

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- The entire column array may be replaced only once.
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Proposed wording:


Delete 4th sub-bullet from bullet item (b). Add new bullet item (b) as follows (all other text in Para. 5.1.1 remains unchanged):

(b) For components with column grid array packages: The entire column array may be replaced only once.

Amend current bullet item '(b)' to be '(c)'

Justification:

Typographic error introduction during implementation of DCR981. Column grid array packages are not limited to flip-chip IC components.

Attachments:
N/A
Modifications:
N/A
Approval signature:

Date signed:
2017-04-19